1A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS		
PARAMETER	**VALUE**	**UNIT**
I_F	1	A
V_{RRM}	100 - 200	V
I_{FSM}	30	A
$T_{J\ MAX}$	175	°C
Package	DO-214AC (SMA)	
Configuration	Single die	

Pb-Free RoHS COMPLIANT HALOGEN FREE

DO-214AC (SMA)

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)					
PARAMETER		**SYMBOL**	**PE1BAH**	**PE1DAH**	**UNIT**
Marking code on the device			PE1BA	PE1DA	
Repetitive peak reverse voltage		V_{RRM}	100	200	V
Reverse voltage, total rms value		$V_{R(RMS)}$	70	140	V
Forward current		I_F	1		A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I_{FSM}	30		A
	t = 1.0ms		100		
Junction temperature		T_J	-55 to +175		°C
Storage temperature		T_{STG}	-55 to +175		°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\Theta JL}$	22	°C/W
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	71	°C/W
Junction-to-case thermal resistance	$R_{\Theta JC}$	22	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS (T_A = 25°C unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage[1]	I_F = 0.5A, T_J = 25°C	V_F	0.79	-	V
	I_F = 1.0A, T_J = 25°C		0.85	0.92	V
	I_F = 0.5A, T_J = 125°C		0.63	-	V
	I_F = 1.0A, T_J = 125°C		0.69	-	V
Reverse current @ rated V_R[2]	T_J = 25°C	I_R	-	2	μA
	T_J = 125°C		-	10	μA
Junction capacitance	1MHz, V_R = 4.0V	C_J	24	-	pF
Reverse recovery time	I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A	t_{rr}	-	15	ns
	I_F = 1.0A, di/dt = 50A/μs, V_R = 30V		23	-	
Reverse recovery current	I_F = 1.0A, di/dt = 200A/μs, V_R = 100V	I_{RM}	1.9	-	A
Reverse recovery charge		Q_{rr}	10.5	-	nC
Reverse recovery time		t_{rr}	12	-	ns

Notes:

1. Pulse test with PW = 0.3ms
2. Pulse test with PW = 30ms

ORDERING INFORMATION

ORDERING CODE[1]	PACKAGE	PACKING
PE1xAH	DO-214AC (SMA)	7,500/ Tape & Reel

Notes:

1. “x” defines voltage from 100V(PE1BAH) to 200V(PE1DAH)

CHARACTERISTICS CURVES

(T_A = 25°C unless otherwise noted)

Fig.1 Forward Current Derating Curve

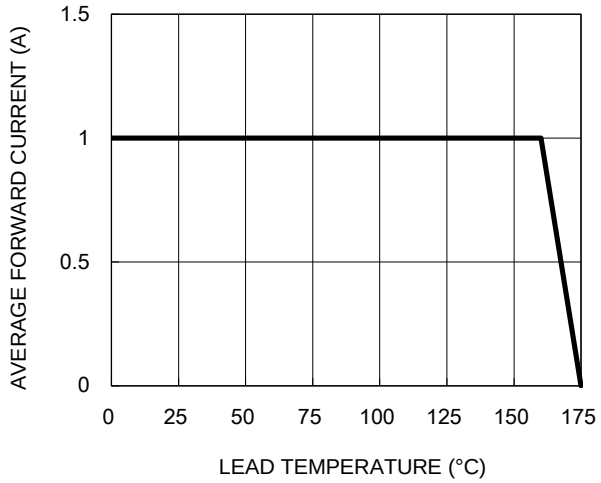


Fig.2 Typical Junction Capacitance

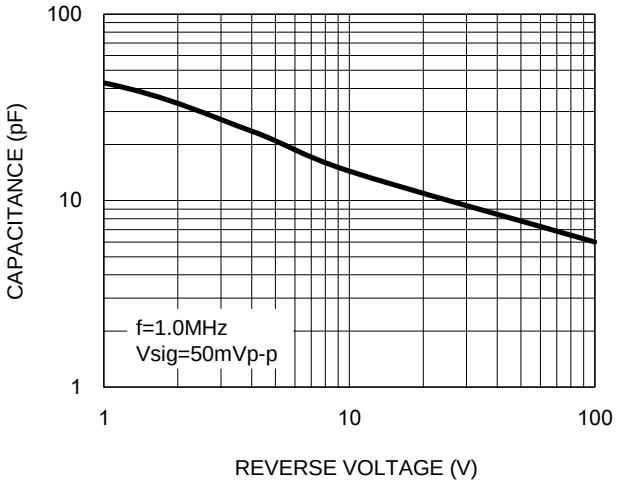


Fig.3 Typical Reverse Characteristics

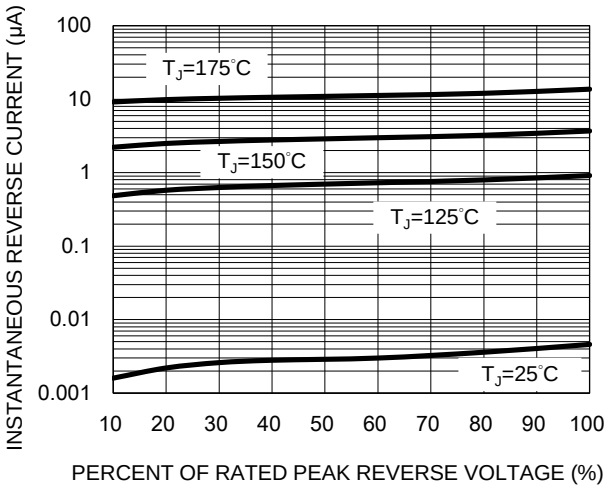


Fig.4 Typical Forward Characteristics

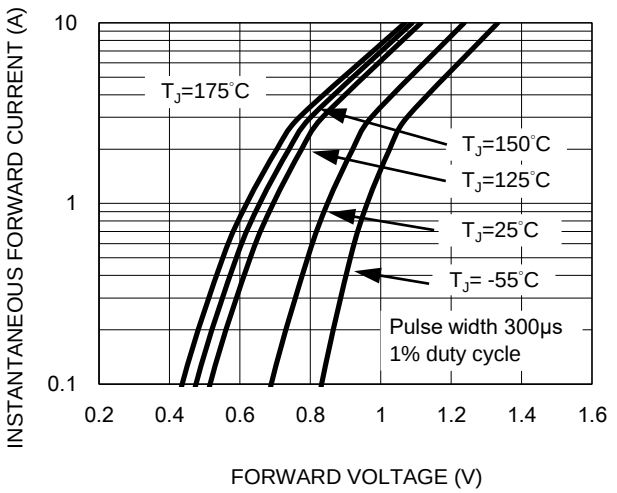
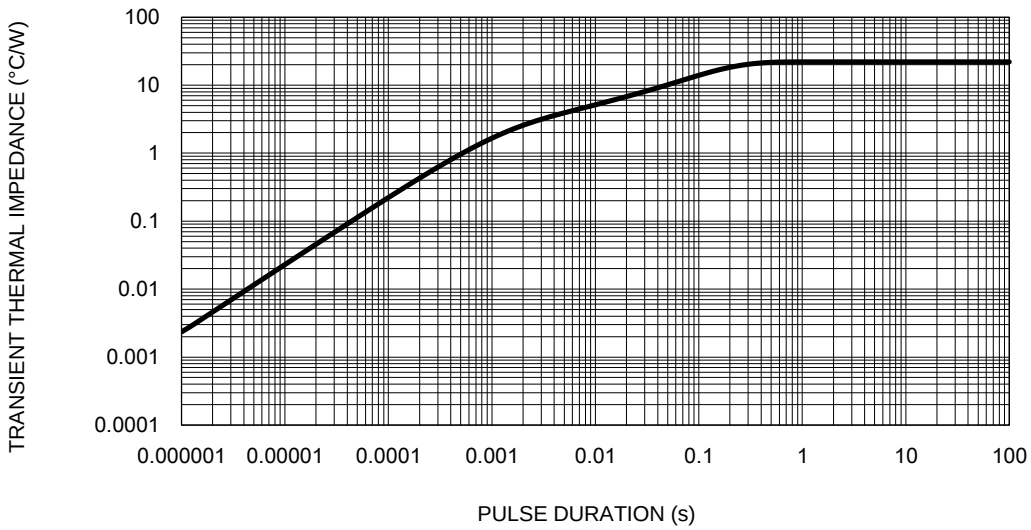
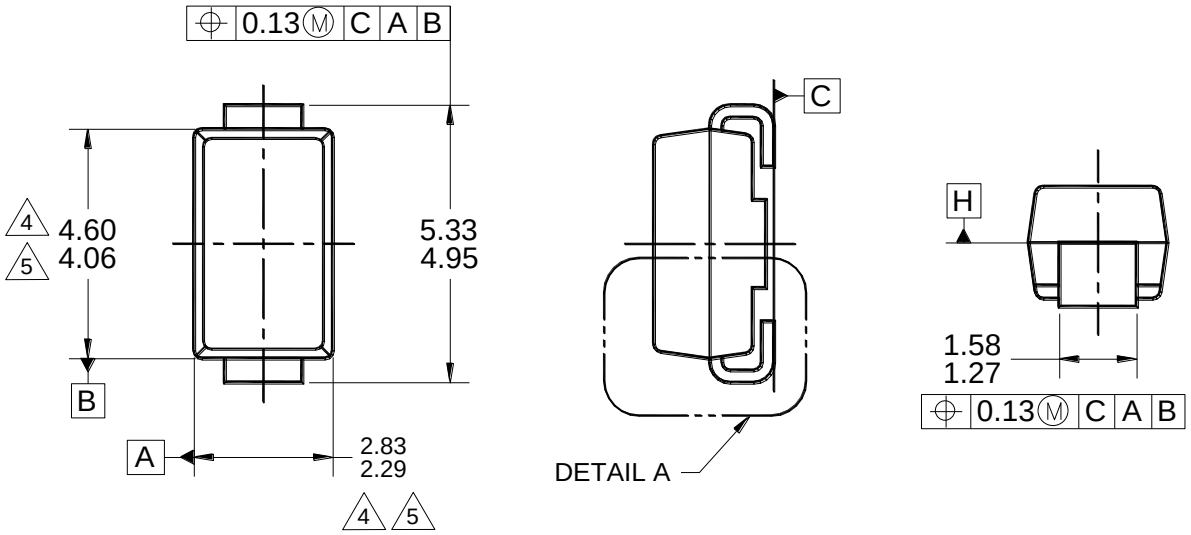


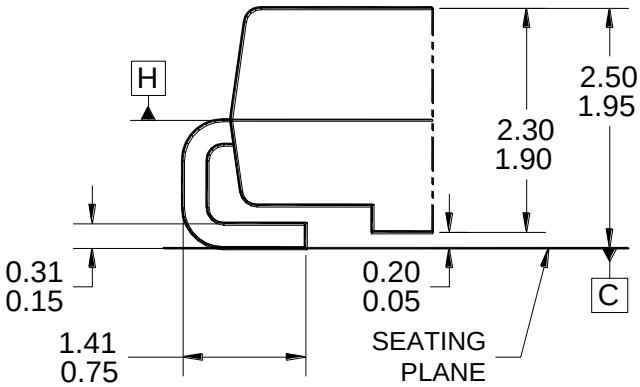
Fig.5 Typical Transient Thermal Impedance



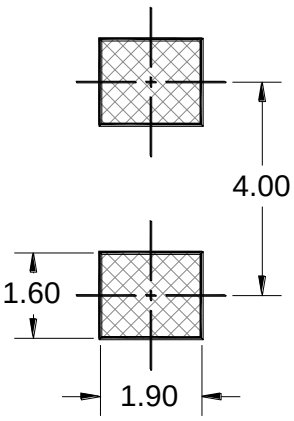
PACKAGE OUTLINE DIMENSIONS

DO-214AC (SMA)

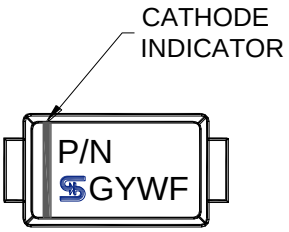




DETAIL A, ROTATED -90°
(SCALE 2:1)



SUGGESTED PAD LAYOUT



MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AC, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-034 REV A.

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